Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO252 (DPAK) plastic package, designed for high frequency switched-mode power supplies.





2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- · Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant

3. Applications

- · Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- · Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Va	ues		Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			6	50		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 136 °C; Fig. 1; Fig. 2; Fig. 3			4		А
T _j	junction temperature		175		°C		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 4 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I _F = 4 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.8	2.1	V
Dynamic	characteristics				•		
Q _r	recovered charge	$I_F = 4 \text{ A}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $V_R = 400 \text{ V}$; $T_j = 25 \text{ °C}$; Fig. 7		-	7	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected		1/ 1/4 A
2	K	cathode [1]		K — A 001aaa020
3	А	anode		
mb	К	mounting base; connected to cathode		

^[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
NXPSC04650D	TO252	NXPSC04650D6J	Reel	2500	TO252NS	14-Nov-2016

7. Marking

Table 4. Marking codes

Type number	Marking codes
NXPSC04650D	NXPSC 04650D

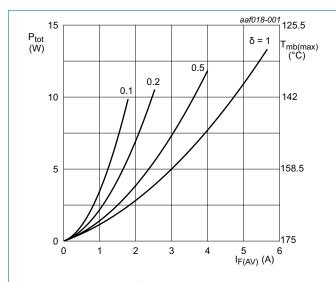
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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		650	V
V_{RWM}	crest working reverse voltage		650	V
V_R	reverse voltage	DC	650	V
I _{F(AV)}	average forward current	$δ$ = 0.5; square-wave pulse; $T_{mb} \le 136$ °C; Fig. 1; Fig. 2; Fig. 3	4	А
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 136 °C; square-wave pulse	8	А
I _{FSM}	non-repetitive peak	$t_p = 10 \text{ ms; } T_{j(init)} = 25 \text{ °C; sine-wave pulse}$	24	А
	forward current	t _p = 10 μs; T _{j(init)} = 25 °C; square-wave pulse	235	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$	2.88	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ V_o = 0.895 V; R_s = 0.2583 Ω

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

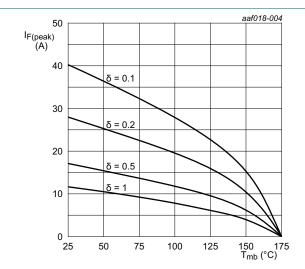
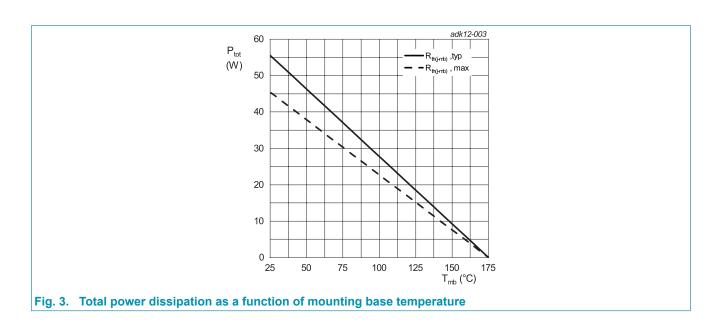


Fig. 2. Current derating as a function of mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4	-	2.7	3.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W

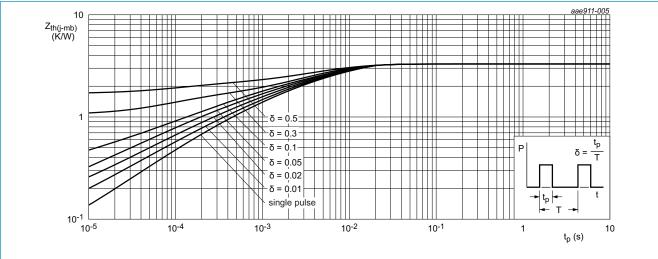
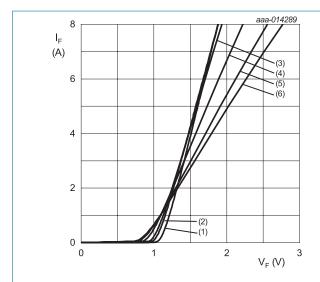


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V_{F}	forward current	I _F = 4 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I _F = 4 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.8	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	-	25	μΑ
		V _R = 650 V; T _j = 150 °C; <u>Fig. 6</u>	-	-	100	μΑ
Dynamic	characteristics					
Q_r	recovered charge	$I_F = 4 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	7	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	141	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	23	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	22	-	pF
E _{as}	non-repetitive avalanche energy	$I_R = 3.5 \text{ A}; L = 5 \text{ mH}; T_{j(init)} = 25 \text{ °C}$	30	-	-	mJ



 $V_o = 0.895 \text{ V}; R_s = 0.2583 \Omega$

(1) $T_j = -55$ °C; typical values (2) $T_j = 0$ °C; typical values

(3) T_j = 25 °C; typical values (4) T_j = 100 °C; typical values

(5) T_i = 150 °C; typical values

(6) T_i = 175 °C; typical values

Fig. 5. Forward current as a function of forward voltage; typical values

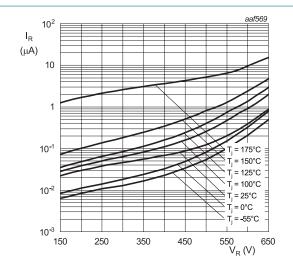
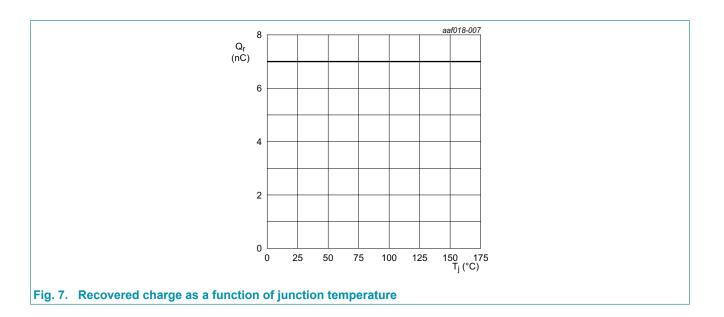


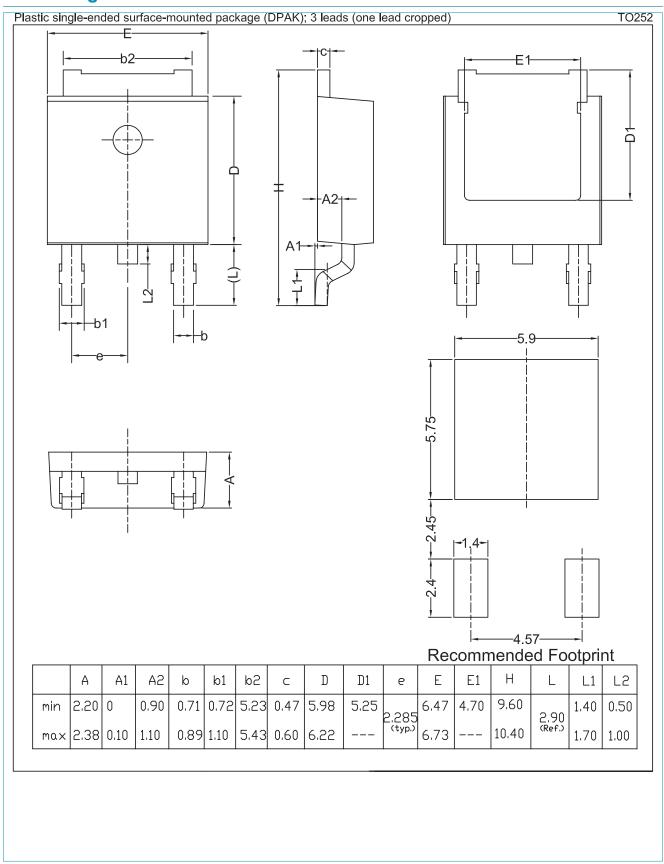
Fig. 6. Reverse leakage current as a function of reverse voltage; typical value



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11. Package outline



12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Product data sheet

13. Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Quick reference data	1
5. Pinning information	2
6. Ordering information	2
7. Marking	2
8. Limiting values	3
9. Thermal characteristics	5
10. Characteristics	6
11. Package outline	8
12. Legal information	9
13. Contents	11

For more information, please visit: http://www.ween-semi.com
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Date of release: 07 November 2019

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